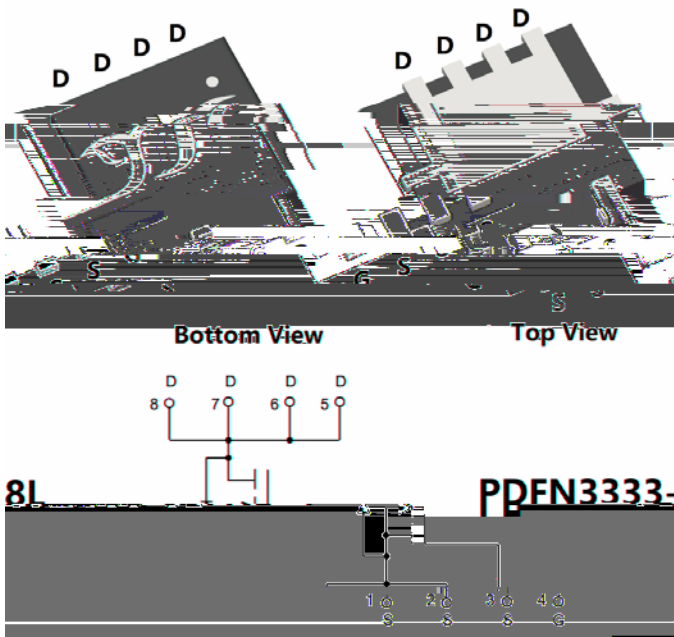




N-Channel Enhancement Mode Field Effect Transistor



Product Summary

V_{DS}	40V
I_D	50A
$R_{DS(ON)}$ (at $V_{GS}=10V$)	6.9m
100% EAS Tested	
100% V_{DS} Tested	

General Description

Excellent package for heat dissipation
 High density cell design for low $R_{DS(ON)}$
 Moisture Sensitivity Level 1
 Epoxy Meets UL 94 V-0 Flammability Rating
 Halogen Free
 Part no. with suffix "Q" means AEC-Q101 qualified

Applications

Power switching application
 Uninterruptible power supply
 DC-DC convertor
 12V Automotive systems

Absolute Maximum Ratings ($T_J=25$ unless otherwise noted)

Parameter			Symbol	Limit	Unit
Drain-source Voltage			V_{DS}	40	V
Gate-source Voltage			V_{GS}	± 20	V
Continuous Drain Current (Note 1,2)	Steady-State	$T_A=25$, $V_{GS}=10V$	I_D	14	A
		$T_A=100$, $V_{GS}=10V$		9.9	
Continuous Drain Current (Note 1,3)	Steady-State	$T_C=25$, $V_{GS}=10V$		50	
		$T_C=100$, $V_{GS}=10V$		35	
Pulsed Drain Current	$T_C=25$, $t_p=100\mu s$		I_{DM}	200	A
Avalanche energy			E_{AS}	68	mJ
Total Power Dissipation (Note 1,2)	Steady-State	$T_A=25$	P_D	2.3	W
		$T_A=100$		1.1	
Total Power Dissipation (Note 1,3)	Steady-State	$T_C=25$		50	
		$T_C=100$		25	
Junction and Storage Temperature Range			T_J, T_{STG}	-55 +175	

Thermal resistance

Parameter		Symbol	Typ	Max	Units
Thermal Resistance Junction-to-Ambient (Note 2)	Steady-State	R_{JA}	55	65	/W
Thermal Resistance Junction-to-Case	Steady-State	R_{JC}	2.4	3	

Ordering Information (Example)

PREFERRED P/N	PACKING CODE	Marking	MINIMUM PACKAGE(pcs)	INNER BOX QUANTITY(pcs)	OUTER CARTON QUANTITY(pcs)	DELIVERY MODE
YJQ6D9G04HHQ	F1	Q6D9G04	5000	10000	100000	13" reel



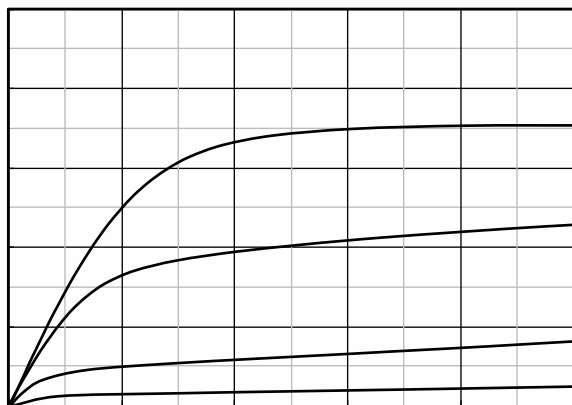
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Electrical Characteristics ($T_J=25$ unless otherwise noted)

Parameter	Symbol	Conditions	Min	Typ	Max	Units
Static Parameter						
Drain-Source Breakdown Voltage	BV_{DSS}	$V_{GS}=0V, I_D=250\mu A$	40	-	-	V
Zero Gate Voltage Drain Current	I_{DSS}	$V_{DS}=40V, V_{GS}=0V$	-	-	1	μA
		$V_{DS}=40V, V_{GS}=0V, T_J=125$	-	-	100	
Gate-Body Leakage Current	I_{GSS}	$V_{GS}=\pm 20V, V_{DS}=0V$	-	-	± 100	nA
Gate Threshold Voltage	$V_{GS(th)}$	$V_{DS}=V_{GS}, I_D=250\mu A$	2	3	4	V
Static Drain-Source On-Resistance	$R_{DS(ON)}$	$V_{GS}=10V, I_D=20A$	-	5.1	6.9	m
Diode Forward Voltage	V_{SD}	$I_S=20A, V_{GS}$				

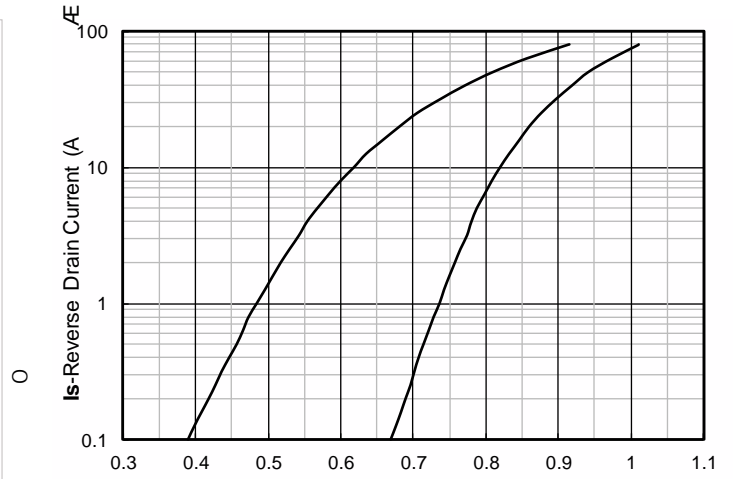
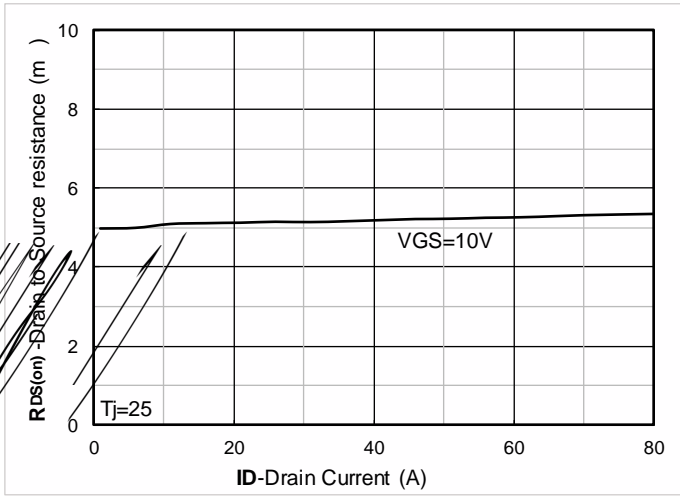


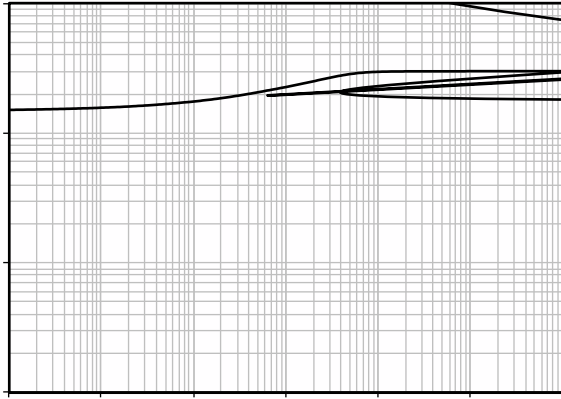
Typical Electrical and Thermal Characteristics Diagrams





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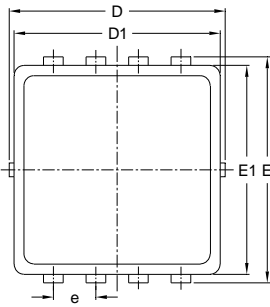




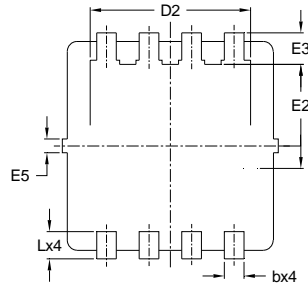


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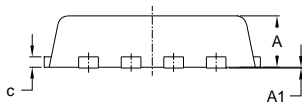
PDFN3333-8L-B-0.75MM Package information



TOP VIEW



BOTTOM VIEW



SIDE VIEW

NOTE:

- 1.PACKAGE BODY SIZES EXCLUDE MOLD FLASH AND GATE BURRS.
- 2.TOLERANCE 0.1mm UNLESS OTHERWISE SPECIFIED.
- 3.THE PAD LAYOUT IS FOR REFERENCE PURPOSES ONLY.

UNIT mm

SUGGESTED SOLDER PAD LAYOUT

'LVFODLPHU

7KH LQIRUPDWLRQ SUHVHQWHG LQ WKLV <DQJ> KRXQJD QVMIRHU (WHIHWHUHQHFRQFHQWUR
ULJKW WR PDNH FKDQJH RU ZWLVK RXSWKHU IRU SURGXFWV RIGWVSOD\HG KHUHLQ WRGLHPSLWRY
RWKHUZZLVH

7KH SURGXFW OLVWJHGHWHUHQHFRQFHQWUR OLIH VDYHQWV LQ OLIHVXVWUDLQJ
VXFK LPSURSHU XVH RI VDOH

7KLV SXEOLFDFWLRQ SXODFHUHQHFRQFHQWUR VDOH VDOH VDOH VDOH VDOH VDOH VDOH
ZZZ \